





Features

- RoHS compliant
- 622 Mbps data rate
- Industry standard 1×9 footprint
- SC Connector
- Single power supply +3.3 V
- Differential LVPECL inputs and outputs
- Compatible with solder and aqueous wash processes
- Class 1 laser product complies with EN 60825-1



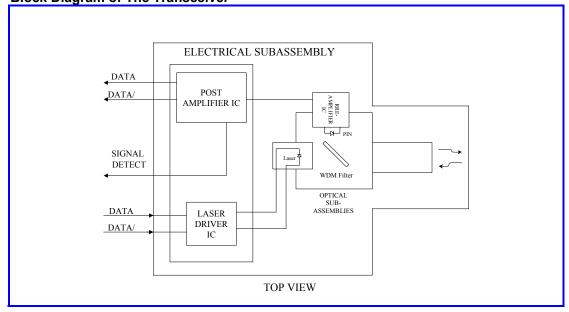
PD-LD Inc. offers single mode laser based fiber optic transceiver modules in convenient industry standard 1x9 style packages. The PTR622 series modules are designed to operate at 622 Mbps data rate over 9/125um single mode optical fiber.

A 1310 nm (-B35)/1550nm (-B53-S) FP and an InGaAs PIN photodiode are integrated with a WDM filter to form a bi-directional single fiber optical subassembly (OSA). A LD driver IC that converts differential input LVPECL logic signals into an analog laser driving current drives the laser. The photodiode

is connected to a circuit providing post-amplification, quantization, and optical signal detection.

Signal Detect indicates the receiving of a good optical signal. This is a single-ended LVPECL output. When the input optical power decreases, Signal Detect will change from high state to low state at a level (de-assert point) below the sensitivity. As the input optical power increases, Signal Detect will change back from low state to high state at assert point. The assert level is at least 1.0 dBm higher than the de-assert level.

Block Diagram of The Transceiver



Specifications Subject to Change

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Ordering Information

acingc				
PART NUMBER	TX	RX	VOLTAGE	TEMPERATURE
PTR622-B35-S01	1310 nm FP	1550 nm	3.3V	0°04 70°0
PTR622-B53-S01	1550 nm FP	1310 nm	J.JV	0°C to 70°C

Absolute Maximum Ratings

Parameter	Symbol	Min.	Max.	Units	Note
Storage Temperature	$T_{\mathtt{S}}$	-0	85	°C	
Supply Voltage	Vcc	-0.5	4.0	V	
Input Voltage	V_{IN}	-0.5	Vcc	V	
Soldering Temperature	T _{SOLD}		260	°C	10 seconds on leads

Recommended Operating Conditions

Parameter	Symbol	Min.	Max.	Untis	Note
Case Operating Temperature	T_{C}	0	70	°C	
Supply Voltage	Vcc	3.15	3.45	V	
Supply Current	$I_{TX} + I_{RX}$		200	mA	

Transmitter Electro-optical Characteristics

 $Vcc = 4.75 \text{ V to } 5.25 \text{ V}, T_A = 0^{\circ} \text{C to } 70^{\circ} \text{C}$

Param	eter	Symbol	Min.	Тур.	Max.	Units	Note
Data Rate		В	50	155	200	Mb/s	
Output Power	-B35	Pout -	-8		-3	dBm	Average
(9/125 μm fiber)	-B53	Fout -	-8		-3	dBm	Average
Extinction Ratio		ER	9			dB	
Center	-B35	2	1270	1310	1350	- nm -	
Wavelength	-B53	— λ _c -	1500	1550	1600	- 11111	
Spectral Width (RM	S)	Δλ		2	4	nm	
Rise/Fall Time, 10%	~90%	T _r , _f		1	2	ns	
Output Eye	Compliant wi	th Telcordia	GR-253-COR	E Issue 3 and	ITU-T recomm	endation G-957	
Data Input Voltage-I	High	$V_{IH} - V_{CC}$	-1.1		-0.74	V	Note 1
Data Input Voltage-I	Low	$V_{IL} - V_{CC}$	-2.0		-1.58	V	Note 1
Data Input Differential Voltage		$V_{\it DIFF}$	0.3		2.4	V	Note 1
Note 1: These inputs are compatible with 10K, 10KH and 100K ECL and PECL input.							

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Receiver Electro-optical Characteristics

 $Vcc = 4.75 \text{ V to } 5.25 \text{ V}, T_A = 0 ^{\circ}\text{C to } 70 ^{\circ}\text{C}$

Parameter	Symbol	Min.	Тур.	Max.	Units	Note
Data Rate	В		622		Mb/s	
Optical Input Power-maximum	Pin	-3			dBm	Note 1
Optical Input Power-minimum (Sensitivity)	P _{IN}			-28	dBm	Note 1
Operating -B35	1	1500		1600	nm	
Wavelength -B53	- λ _c -	1270		1350	11111	
Signal Detect-Asserted	P_A			-28	dBm	Average
Signal Detect-De-asserted	P₀	-40			dBm	Average
Signal Detect-Hysteresis	$P_A - P_D$	1.0		4	dB	
Signal Detect Output voltage - High	$V_{OH} - V_{CC}$	-1.1		-0.74	V	
Signal Detect Output voltage - Low	V _{OL} –V _{CC}	-2.0		-1.58	V	
Crosstalk	CRT			-40	dB	
Data Output Rise, Fall Time	T _{r, f}		1	2	ns	
Data Output Voltage-High	V _{OH} – V _{CC}	-1.1		-0.90	V	
Data Output Voltage-Low	$V_{OL} - V_{CC}$	-1.9		-1.55	V	

Note 1: The input data is at 622 Mbps, 2^{23} – 1 PRBS data pattern with 72 "1"s and 72 "0"s inserted per the ITU-T recommendation G.958 Appendix 1. The receiver is guaranteed to provide output data with Bit Error Rate (BER) better than or equal to 1×10^{-10} .

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Connection Diagram

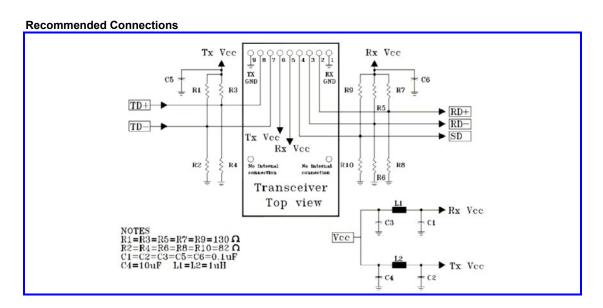
Connection Diagram			
Pin-Out			
i iii Guk	1. RX GND 2. RD+ 3. RD- 4. SD 5. VCCR 6. VCCT 7. TD- 8. TD+	O N/C TOP VIEW	
	9. TX GND	O	
			J

Pin	Symbol	Description
1	RX GND	Receiver Signal Ground This pin should be connected directly to the receiving ground plane
2	RD+	RD+ is an open-emitter output signal. This high-speed differential LVPECL output should be terminated with standard LVPECL termination close the input pin of the next-stage device. (See recommended connection diagram)
3	RD-	RD- is an open-emitter output signal. This high-speed differential LVPECL output should be terminated with standard LVPECL termination close the input pin of the next-stage device. (See recommended connection diagram)
4	SD	Signal Detect. SD outputs a logic "1" (asserted) when optical input is above the asserted levels, and a logic "0" (deasserted) when the optical input is below the de-assert level. SD can be terminated with 50 Ω to V_{CCR} – 2 V, or with a 510 Ω resistor to the RX GND to conserve electrical power with a minor compromise to signal quality. If Signal Detect output is not used, it can be left open. This Signal Detect output can be used to drive a PECL input.
5	V _{CCR}	Receiver Power Supply This pin should be connected to +3.3 Vdc with proper filtering closely located.
6	V _{CCT}	Transmitter Power Supply This pin should be connected to +3.3 Vdc with proper filtering closely located.
7	TD-	Transmitter Data In-Bar This high-speed differential LVPECL input should be terminated with standard LVPECL termination close the pin. (See recommended connection diagram)
8	TD+	Transmitter Data In This high-speed differential LVPECL input should be terminated with standard LVPECL termination close the pin. (See recommended connection diagram)
9	TX GND	Transmitter Signal Ground This pin should be connected directly to the transmitting ground plane

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A connection circuit is recommended in the above diagram. The following guidelines are also recommended for designing the interface circuit:

- (1) For the high speed signal lines, differential signals should be used, not single-ended signals, and these differential signals need to be loaded symmetrically to prevent unbalanced currents which will cause distortion in the signal.
- (2) Multi layer plane PCB is best for distribution of V_{CC} , returning ground currents, forming transmission lines and shielding, Also, it is important to suppress noise from influencing the fiber-optic transceiver performance, especially the receiver circuit.
- (3) A separate proper power supply filter circuits shown in Figure for the transmitter and receiver sections. These filter circuits suppress V_{CC} noise over a broad frequency range. This prevents receiver sensitivity degradation due to V_{CC} noise.
- (4) Surface-mount components are recommended. Ceramic bypass capacitors should be used for the 0.1 μ F capacitors and a surface-mount coil inductor for 1 μ H inductor. Ferrite beads can be used to replace the coil inductors when using quieter V_{CC} supplies, but a coil inductor is recommended over a ferrite bead. All power supply components need to be placed physically next to the V_{CC} pins of the receiver and transmitter.
- (5) A good, uniform ground plane with a minimum number of holes should be used to provide a low-inductance ground current return for the power supply currents.

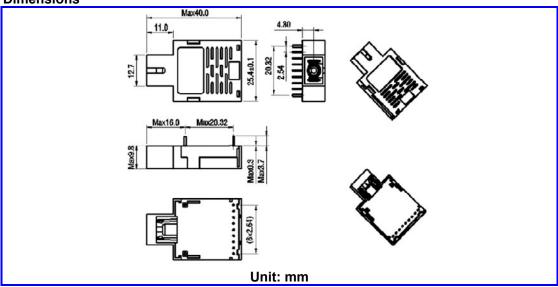
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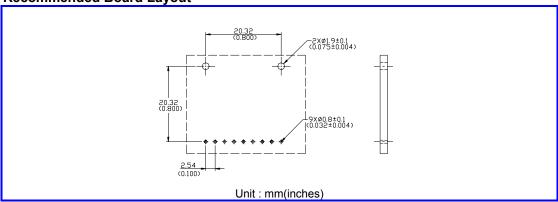
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Dimensions



Recommended Board Layout



This transceiver is compatible with industry standard wave or hand solder processes. After wash process, all moisture must be completely removed from the module. The transceiver is supplied with a process plug to prevent contamination during wave solder and aqueous rinse as well as during handling, shipping or storage.

Solder fluxes should be water-soluble, organic solder fluxes. Cleaning and degreasing chemicals recommended for these transceivers are alcohol-based (methyl, isopropyl, isobutyl), aliphatic-based (hexane, heptanes) and other chemicals, such as soap solution or naphtha. Do not use partially halogenated hydrocarbons for cleaning/degreasing.

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10/2009

03/16 / V2 / IF / pd_ld/ptr622-b35_b53